

Pb Free Plating Product

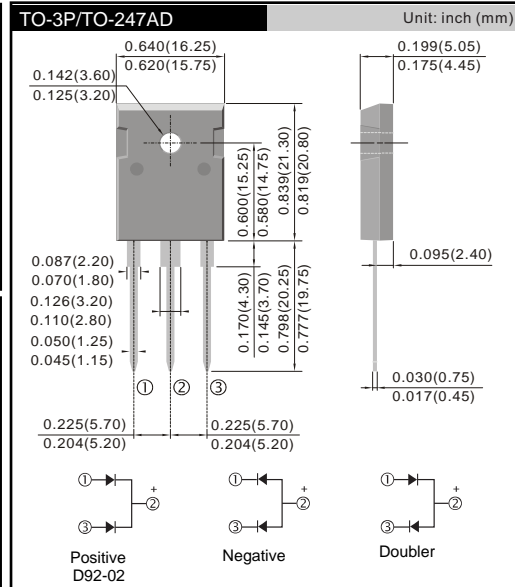
D92-02



Ultrafast Recovery Rectifier

- ### Features
- Ultrafast Recovery Time
 - Soft Recovery Characteristics
 - Low Recovery Loss
 - Low Forward Voltage
 - High Surge Current Capability
 - Low Leakage Current

- ### APPLICATIONS
- Freewheeling, Snubber, Clamp
 - Inversion Welder
 - PFC
 - Plating Power Supply
 - Ultrasonic Cleaner and Welder
 - Converter & Chopper
 - UPS



ABSOLUTE MAXIMUM RATINGS

T_C=25°C unless otherwise specified

Symbol	Parameter	Test Conditions	Values	Unit
V _R	Maximum D.C. Reverse Voltage		220	V
V _{RRM}	Maximum Repetitive Reverse Voltage		220	V
I _{F(AV)}	Average Forward Current	T _C =110°C, Per Diode	10	A
		T _C =110°C, Per Package	20	A
I _{F(RMS)}	RMS Forward Current	T _C =110°C, Per Diode	14	A
I _{FSM}	Non-Repetitive Surge Forward Current	T _J =45°C, t=10ms, 50Hz, Sine	100	A
P _D	Power Dissipation		83	W
T _J	Junction Temperature		-40 to +150	°C
T _{STG}	Storage Temperature Range		-40 to +150	°C
Torque	Module-to-Sink	Recommended (M3)	1.1	N·m
R _{θJC}	Thermal Resistance	Junction-to-Case	1.5	°C/W
Weight			6.0	g

ELECTRICAL CHARACTERISTICS

T_C=25°C unless otherwise specified

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I _{RM}	Reverse Leakage Current	V _R =220V	--	--	50	μA
		V _R =220V, T _J =125°C	--	--	1	mA
V _F	Forward Voltage	I _F =10A	--	0.86	0.95	V
		I _F =10A, T _J =125°C	--	--	0.80	V
t _{rr}	Reverse Recovery Time	I _F =1A, V _R =30V, di _F /dt=-200A/μs	--	25	--	ns
t _{rr}	Reverse Recovery Time	V _R =100V, I _F =10A	--	32	--	ns
I _{RRM}	Max. Reverse Recovery Current	di _F /dt=-200A/μs, T _J =25°C	--	2.1	--	A
t _{rr}	Reverse Recovery Time	V _R =100V, I _F =10A	--	45	--	ns
I _{RRM}	Max. Reverse Recovery Current	di _F /dt=-200A/μs, T _J =125°C	--	5	--	A

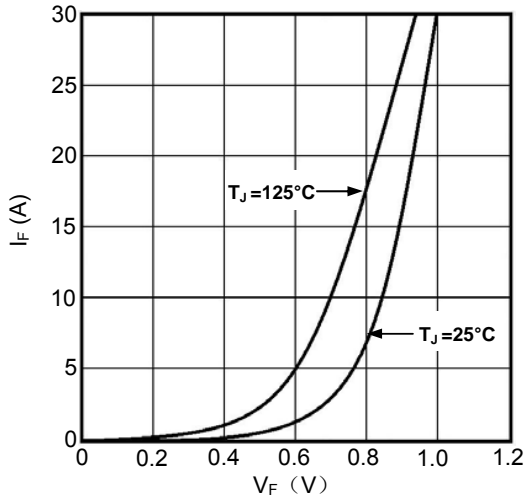


Fig1. Forward Voltage Drop vs Forward Current

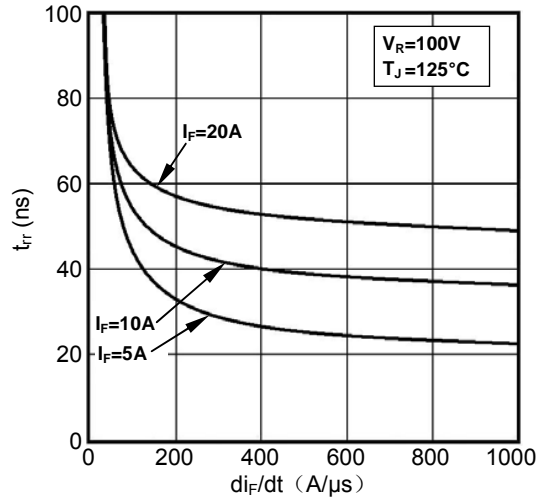


Fig2. Reverse Recovery Time vs diF/dt

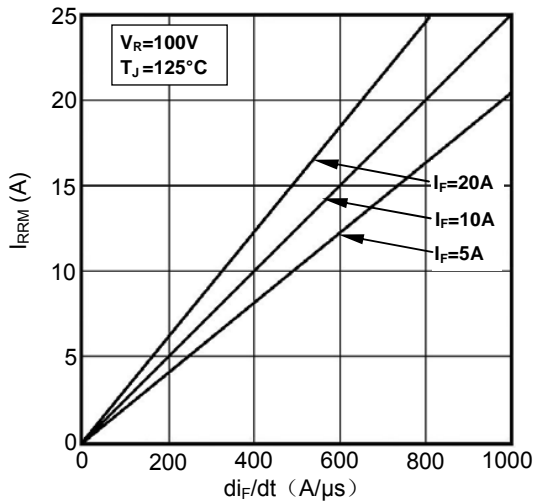


Fig3. Reverse Recovery Current vs diF/dt

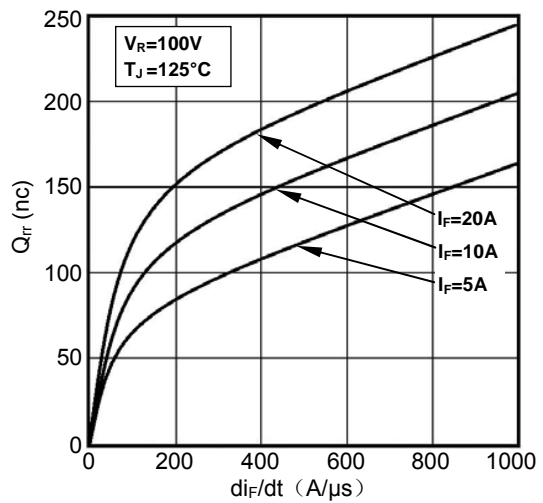


Fig4. Reverse Recovery Charge vs diF/dt

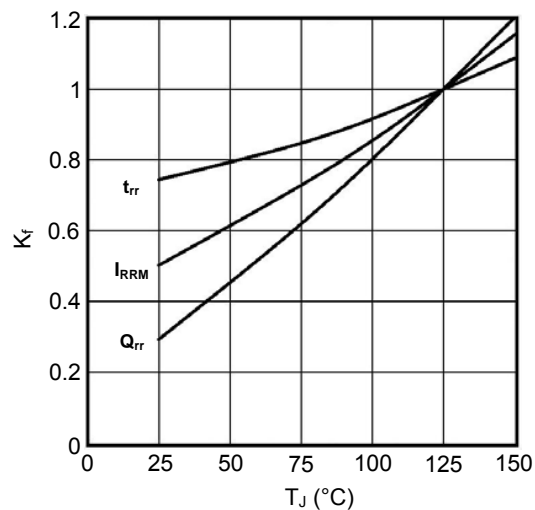


Fig5. Dynamic Parameters vs Junction Temperature

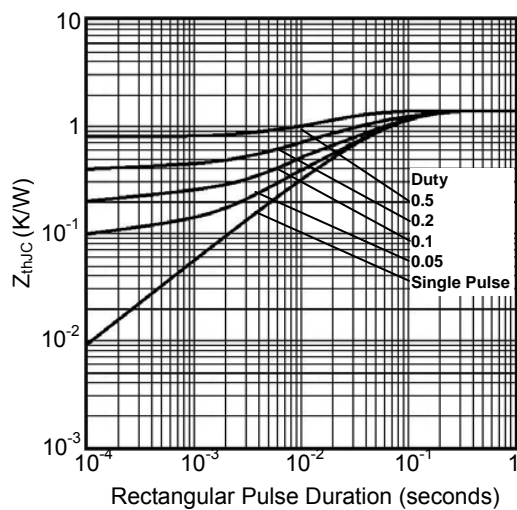


Fig6. Transient Thermal Impedance